



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**  
**(123869.1)**

<b>Applicant:</b>	<b>Alan R. Pfaff, Jr.</b>	<b>Paper Number:</b>	<b>4</b>
<b>U.S.S.N:</b>	<b>10/730,580</b>	<b>Art Unit:</b>	<b>3724</b>
<b>Filing Date:</b>	<b>12/08/03</b>	<b>Examiner:</b>	<b>Hamilton, I.</b>
<b>Title:</b>	<b>ROTARY CUTTING TOOL WITH DIE PLATE POSITION ADJUSTMENT</b>		

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Assistant Commissioner for Patents  
Washington, DC 20231

Sir:

The following is a Response to the First Office Action mailed on March 25, 2005  
in the above captioned patent application.

In the Drawings

Attached with the Response is a revised Fig. 1, moving lead line 14 to touch the  
die cylinder. No new matter has been added. Applicant respectfully requests entry of  
this revised Fig. 1.